/ Descriptions

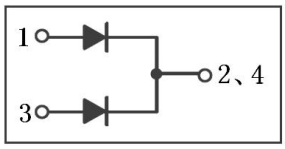
TO-263

/ Features

/ Applications

OR-ing DC-DC

/ Equivalent Circuit



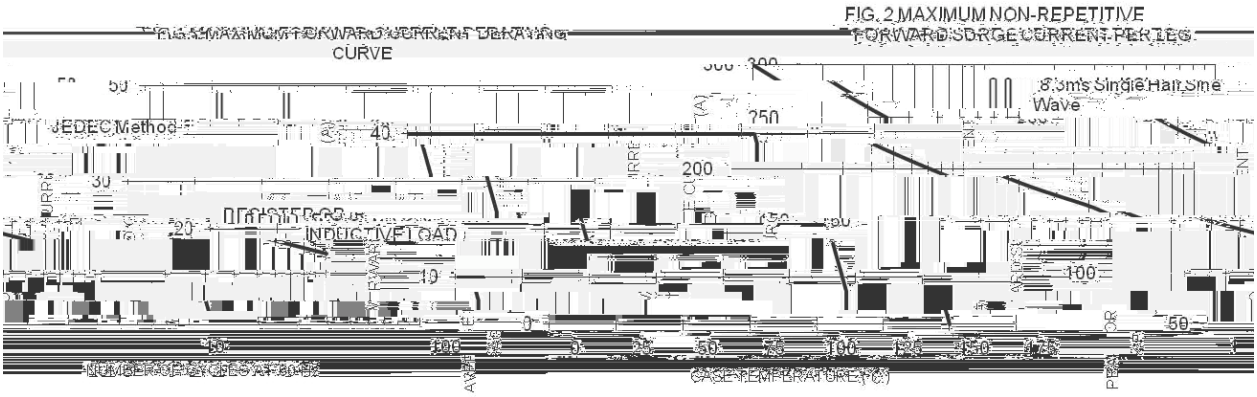
/ Pinning

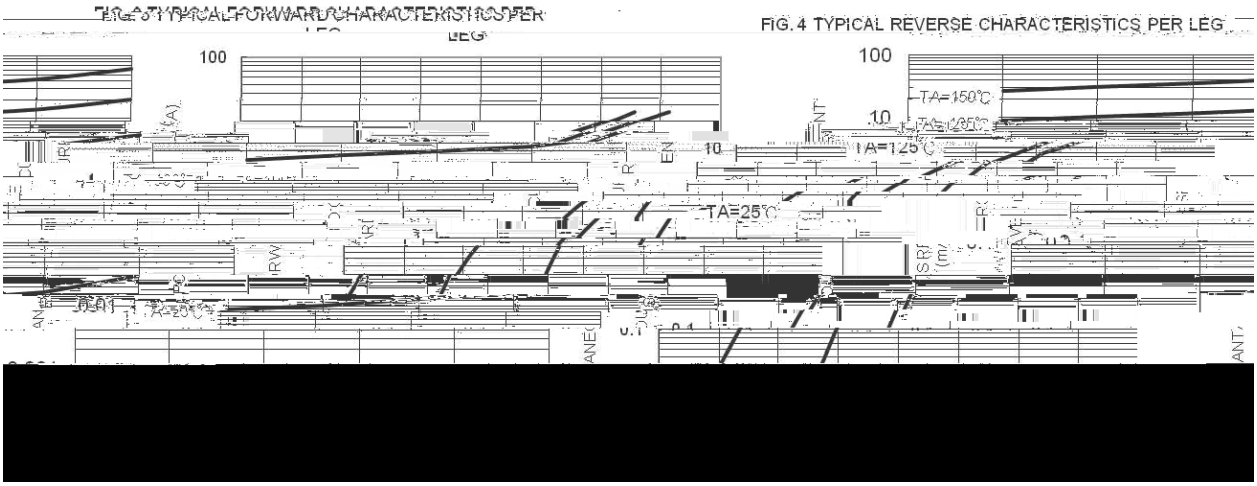


/ h_{FE} Classifications & Marking

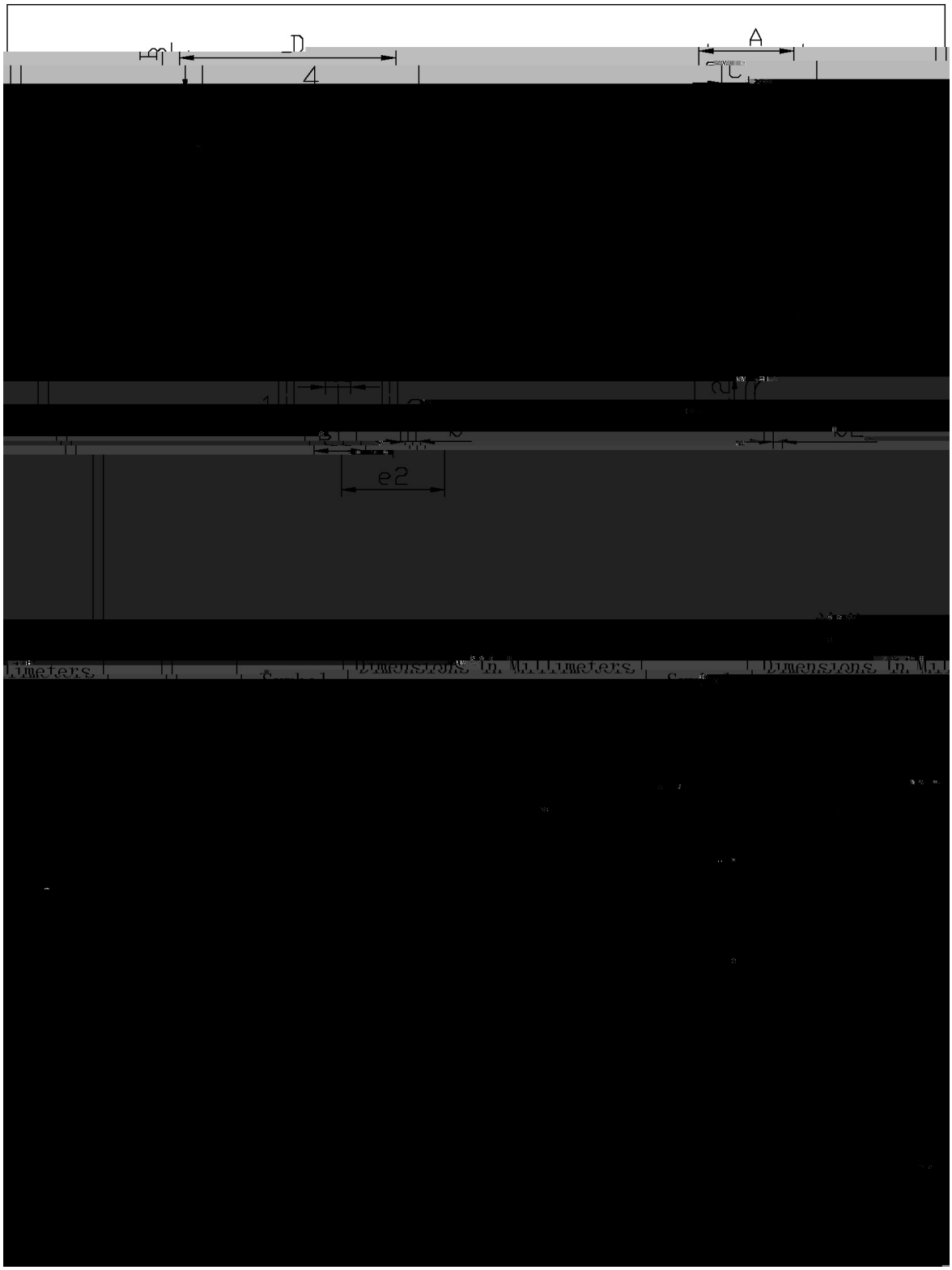
	θ		

/ Electrical Characteristic Curve

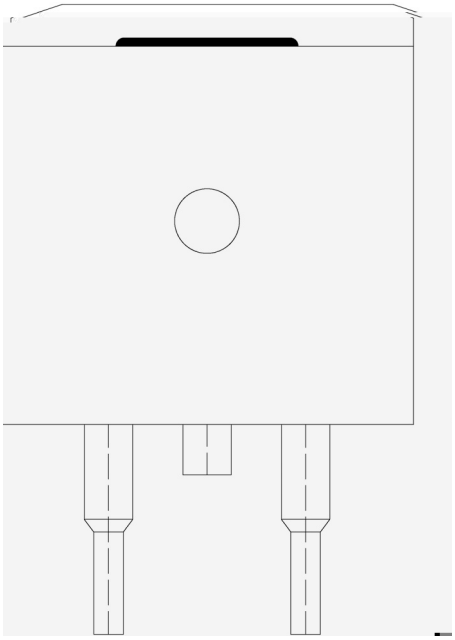




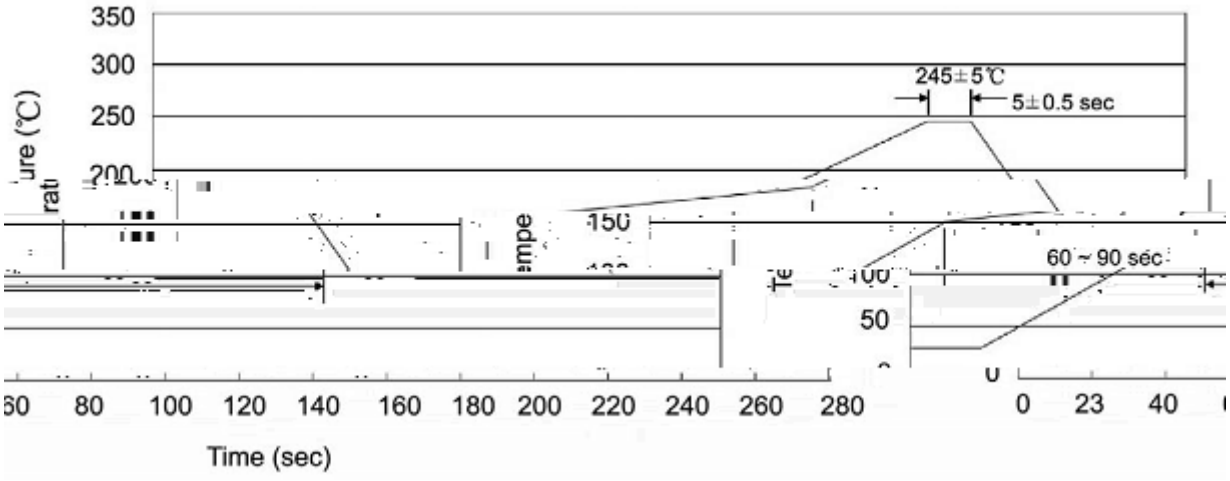
/ Package Dimensions



/ Marking Instructions



( ) / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

	Units/Reel / Reels/Inner Box / Units/Inner Box	